

P-Channel 40 V (D-S) MOSFET

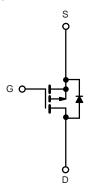
V _{DS}		-40	V
RDS(on),typ	VGS=10V	10	mΩ
RDS(on),typ	VGS=4.5V	14	mΩ
١D		-55	А

FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Power Switch
- DC/DC Converters



P-Channel MOSFET

ABSOLUTE MAXIMUM RAT	INGS (T _C = 25 °C, unless of	otherwise noted)		
Parameter		Symbol	Limit	Unit
Gate-Source Voltage		V _{GS}	± 20	V
	T _C = 25 °C		- 55 ^a	
Continuous Drain Current (T _J = 175 °C)	T _C = 125 °C	I _D	- 50	А
Pulsed Drain Current		I _{DM}	- 220	
Avalanche Current		I _{AR}	- 60	
Repetitive Avalanche Energy ^b	L = 0.1 mH	E _{AR}	180	mJ
Devuer Dissingtion	T _C = 25 °C	Р	45	W
Power Dissipation	T _A = 25 °C	P _D –	3.75	V
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C

THERMAL RESISTANCE	RATINGS			
Parameter		Symbol	Limit	Unit
Junction-to-Ambient	PCB Mount (TO-263) ^c	Р	40	
Sunction-to-Ambient	Free Air (TO-220AB)	– R _{thJA}	62.5	°C/W
Junction-to-Case		R _{thJC}	0.8	

Notes:

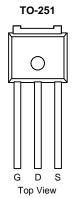
a. Package limited.

b. Duty cycle \leq 1 %.

c. When mounted on 1" square PCB (FR-4 material).

d. See SOA curve for voltage derating.

* Pb containing terminations are not RoHS compliant, exemptions may apply.





Deremeter	Currente e l	Test Can ditions	M:	There	Merr	11	
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static		1					
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = - 250 μA	- 40			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	- 1.0		- 2.5		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
		$V_{DS} = -40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1		
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = - 40 V, V_{GS} = 0 V, T_{J} = 125 °C			- 50	nA μA MΩ S PF nC nS A V ns	
		V_{DS} = - 40 V, V_{GS} = 0 V, T_{J} = 175 °C			- 250	<u> </u>	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} = -5 V, V_{GS} = -10 V$	- 120			А	
		V _{GS} = - 10 V, I _D = - 30 A		10			
Drain Source On State Desistence	Р	V_{GS} = - 10 V, I _D = - 30 A, T _J = 125 °C		16			
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 10 V, I _D = - 30 A, T _J = 175 °C		23		1115.2	
		V _{GS} = - 4.5 V, I _D = - 20 A		14			
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 75 A	20			S	
Dynamic ^b		· · · · · · · · · · · · · · · · · · ·					
Input Capacitance	C _{iss}			3000			
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = - 25 V, f = 1 MHz		620		pF	
Reversen Transfer Capacitance	C _{rss}			315			
Total Gate Charge ^c	Qa				90		
Gate-Source Charge ^c		V _{DS} = - 15 V, V _{GS} = - 10 V, I _D = - 75 A			32	nC	
Gate-Drain Charge ^c	Qg				30		
Turn-On Delay Time ^c	t _{d(on)}			25	40		
Rise Time ^c	t _r	$V_{DD} = -15 \text{ V}, \text{ R}_{1} = 0.2 \Omega$		225	360		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong -75 \text{ A}, \text{ V}_{\text{GEN}} = -10 \text{ V}, \text{ R}_{\text{g}} = 2.5 \Omega$		150	240	ns	
Fall Time ^c	t _f			210	340		
Source-Drain Diode Ratings and Cha	racteristics ^b	(T _C = 25 °C)					
Continuous Current	۱ _s			- 220			
Pulsed Current	I _{SM}				- 240	A	
Forward Voltage ^a	V _{SD}	I _F = - 75 A, V _{GS} = 0 V		- 1.2	- 1.5	V	
Reverse Recovery Time	t _{rr}			55	100	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = - 75 A, dl/dt = 100 A/μs		2.5	5	A	
Reverse Recovery Charge		· · · · · · · · · · · · · · · · · · ·		0.07	0.25	μC	

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

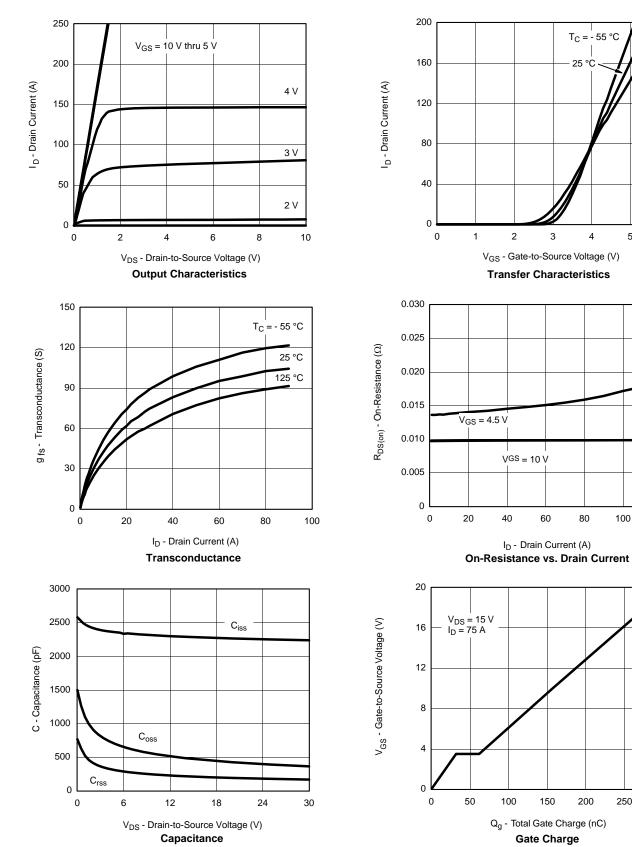


125 °C

T_C = - 55 °C

25 °C

Gate Charge



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



T_J = 25 °C

1.0

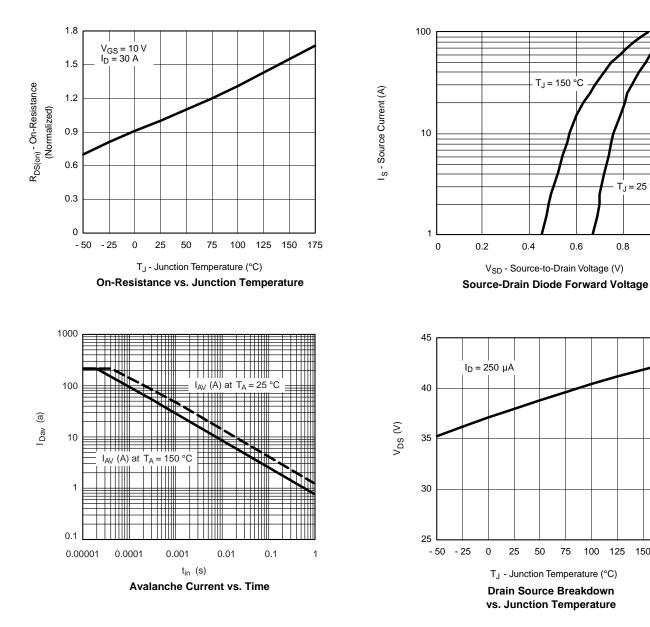
0.8

0.6

75

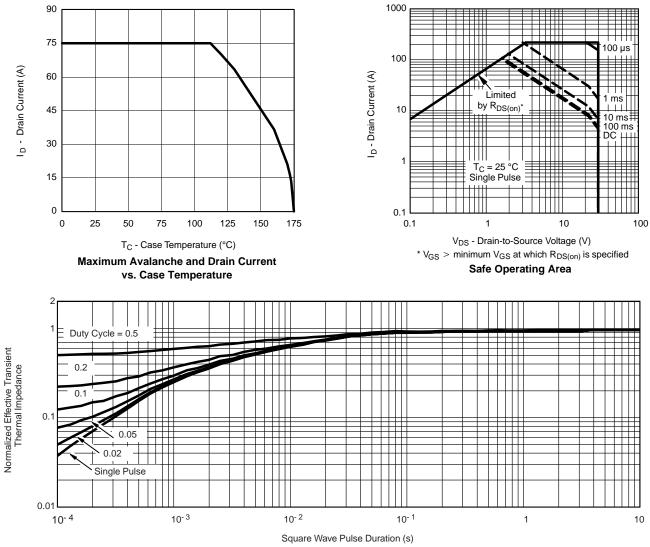
100 125 150 175







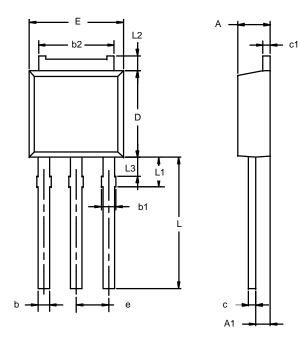
THERMAL RATINGS



Normalized Thermal Transient Impedance, Junction-to-Case



TO-251AA (DPAK)



Note: Dimension L3 is for reference only.

	MILLIMETERS		INCHES		
Dim	Min	Мах	Min	Max	
Α	2.21	2.38	0.087	0.094	
A1	0.89	1.14	0.035	0.045	
b	0.71	0.89	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.43	0.206	0.214	
С	0.46	0.58	0.018	0.023	
c1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
Е	6.48	6.73	0.255	0.265	
е	2.28 BSC		0.090 BSC		
L	8.89	9.53	0.350	0.375	
L1	1.91	2.28	0.075	0.090	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.045	0.060	
ECN: S-0 DWG: 53	3946—Rev. E 346	E, 09-Jul-01			



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